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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
SEUL KI MIN	05/21/2019	

RECEIVING PARTY DATA

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State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	29694375	

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NAME OF SUBMITTER:	YOON S. HAM
SIGNATURE:	/Yoon S. Ham/
DATE SIGNED:	06/10/2019

Total Attachments: 1

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PATENT REEL: 049424 FRAME: 0419

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(b)	for which an application for United States Lette	ers Patent was e	xecuted on		
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